

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	58292	"sih.sub.4" "o.sub.4"	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/12 07:22
L3	0	"sih.sub.4" adj "o.sub.4"	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/12 07:23
L4	1999164	si(oh)	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/12 07:24
L5	1999164	si(oh)4	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/12 07:25
L6	19	"6268282"	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/12 07:34
L7	18	"6121133"	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/12 07:34

L8	2077	(oxygen near5 material) with (exposed unexposed exposure unexposure)	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/12 07:36
L9	49744	8 (energy) with (exposed unexposed exposure unexposure)	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/12 07:37
L10	227	8 and (energy) with (exposed unexposed exposure unexposure)	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/12 07:37
L11	99	10 and (substrate) with (exposed unexposed exposure unexposure)	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/12 07:37
S1	880	"sih.sub.4" adj "n.sub.2" adj o	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/11 12:49
S2	406	si adj "o.sub.2"	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/11 12:49

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L12	11	energy and (substrate with (exposed unexposed exposure unexposure)) with ((oxygen 'o2') near4 material).clm.	US-PGPU B; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/12 08:12

S3	130	"sih.sub.4"" adj ""n.sub.2"" adj o with (si adj "o.sub.2" silicon adj oxide)	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/07/12 07:21
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